

DO NOT

SCALE FROM THIS PRINT

THIS PRODUCT MANUFACTURED WITH LEAD-FREE PROCESSING

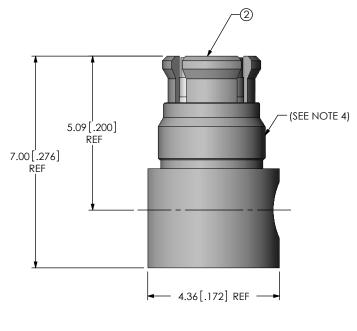
DESIGNED & DIMENSIONED IN MILLIMETERS[INCHES]

SMP-J-C-XX-RA-CS5 GENDER--J: JACK TERMINATION -CS5: MWC-2550-01 CABLE

(SEE TABLE 1)

ORIENTATION **TYPE** -RA: RIGHT ANGLE -C: CABLE

> -PLATING SPECIFICATION -HG: HEAVY GOLD / GOLD 30µ" Au / 50µ" Ni MIN ON PIN 10µ" Au / 50µ" Ni MIN ON OUTER CONTACT 3µ" Au / 50µ" Ni MIN ON CAP -GF: GOLD / FLASH GOLD 10µ" Au / 50µ" Ni MIN ON PIN 3µ" Au / 50µ" Ni MIN ON OUTER CONTACT 100µ" Ni MIN ON CAP



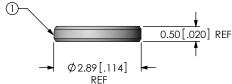


TABLE 1			
ITEM	COMPONENT	-HG	-GF
1	CAP	MMCX-CAP-001-F	MMCX-CAP-001-N
2	SUB ASSEMBLY	SUB-SMP-J-C-HG-RA-CS5	SUB-SMP-J-C-GF-RA-CS5

UNLESS OTHERWISE SPECIFIED. DIMENSIONS ARE IN MILLIMETERS. TOLERANCES ARE:

DECIMALS ANGLES X.X: ±0.3 [.01] X.XX: ±0.13 [.005] X.XXX: ±0.051 [.0020]

MATERIAL:

CAP: BRASS

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SHEET SCALE: 8:1

SUB ASSEMBLY: INSULATOR: PTFE BODY, RING & SOCKET: BeCu

DO NOT SCALE DRAWING

NOTES:

1. (C) REPRESENTS A CRITICAL DIMENSION.

2. PRODUCT TO BE PACKAGED PER PACKING STANDARD CO-HD-WI-3040-M. TRAY: TY-SMA001-1 COVER: TY-SMA001-2

COVEN: 11-3MAUU1-2
200 PARTS PER TRAY (2 PARTS PER POCKET)
3. CAP TO BE PACKAGED SEPARATELY.
4. THE RING IS LOOSE AND CAN MOVE, 1.5 LBS MIN FORCE TO REMOVE.

A

F:\DWG\MISC\MKTG\SMP-J-C-XX-RA-CS5-MKT.SLDDRW

SMP RA JACK FOR MWC-2550-01 - 50 OHM

SMP-J-C-XX-RA-CS5

07/20/2011 SHEET 1 OF 2 BY: ALVIN W

